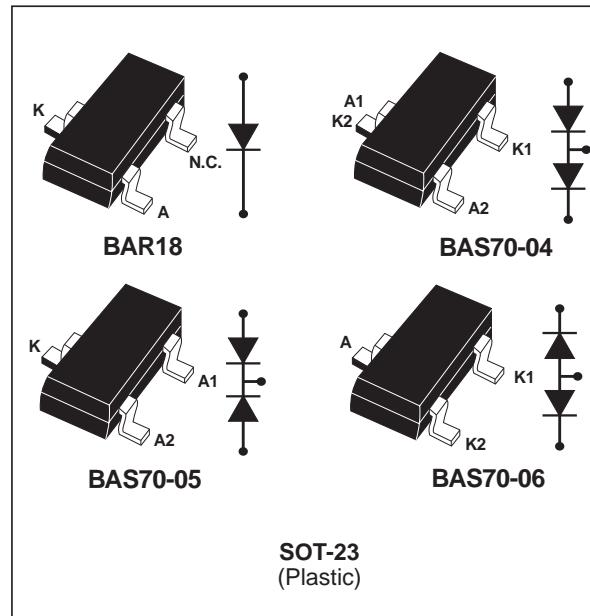


## SMALL SIGNAL SCHOTTKY DIODES



### DESCRIPTION

Low turn-on and high breakdown voltage diodes intended for ultrafast switching and UHF detectors in hybrid micro circuits.

### ABSOLUTE RATINGS (limiting values)

Symbol	Parameter		Value	Unit
V <sub>RRM</sub>	Repetitive peak reverse voltage		70	V
I <sub>F</sub>	Continuous forward current		70	mA
P <sub>tot</sub>	Power dissipation (note 1)	T <sub>amb</sub> = 25°C	250	mW
T <sub>stg</sub>	Maximum storage temperature range		- 65 to +150	°C
T <sub>j</sub>	Maximum operating junction temperature *		150	°C
T <sub>L</sub>	Maximum temperature for soldering during 10s		260	°C

Note 1: for double diodes, P<sub>tot</sub> is the total dissipation of both diodes

$$* : \frac{dP_{tot}}{dT_j} < \frac{1}{R_{th}(j-a)} \text{ thermal runaway condition for a diode on its own heatsink}$$

### THERMAL RESISTANCE

Symbol	Parameter	Value	Unit
R <sub>th</sub> (j-a)	Junction to ambient (*)	500	°C/W

(\*) Mounted on epoxy board with recommended pad layout.

## ELECTRICAL CHARACTERISTICS

### STATIC CHARACTERISTICS

Symbol	Test Conditions	Min.	Typ.	Max.	Unit
$V_{BR}$	$T_j = 25^\circ\text{C}$ $I_R = 10\mu\text{A}$	70			V
$V_F^*$	$T_j = 25^\circ\text{C}$ $I_F = 1\text{mA}$			410	mV
$I_R^{**}$	$T_j = 25^\circ\text{C}$ $V_R = 50\text{V}$			200	nA

Pulse test: \*  $t_p = 380\mu\text{s}$ ,  $\delta < 2\%$

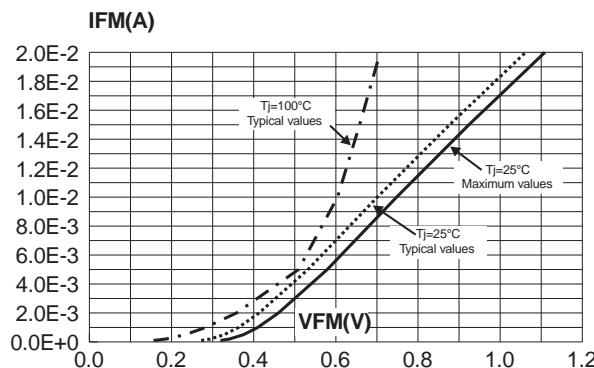
\*\*  $t_p = 5 \text{ ms}$ ,  $\delta < 2\%$

### DYNAMIC CHARACTERISTICS

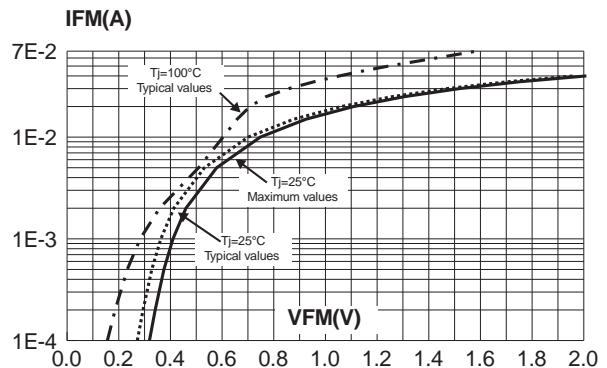
Symbol	Test Conditions	Min.	Typ.	Max.	Unit
C	$T_j = 25^\circ\text{C}$ $V_R = 0\text{V}$ $F = 1\text{MHz}$			2	pF
$\tau^*$	$T_j = 25^\circ\text{C}$ $I_F = 5\text{mA}$ Krakauer Method			100	ps

\* Effective carrier life time.

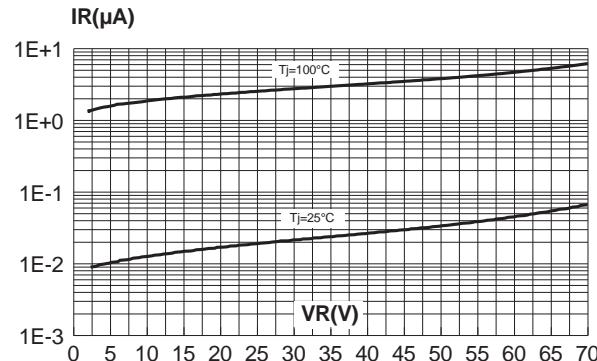
**Fig. 1-1:** Forward voltage drop versus forward current (low level).



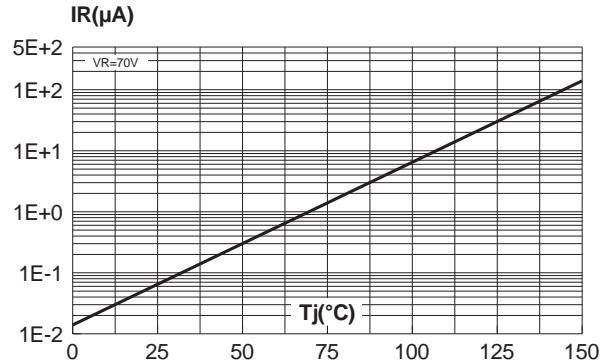
**Fig. 1-2:** Forward voltage drop versus forward current (high level).



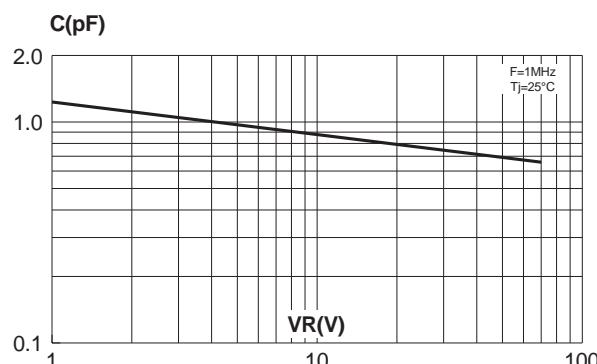
**Fig. 2:** Reverse leakage current versus reverse voltage applied (typical values).



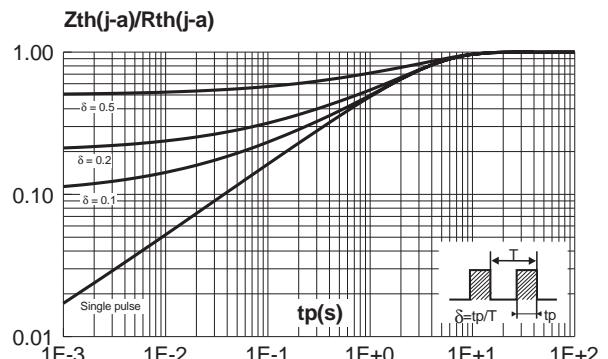
**Fig. 3:** Reverse leakage current versus junction temperature (typical values)



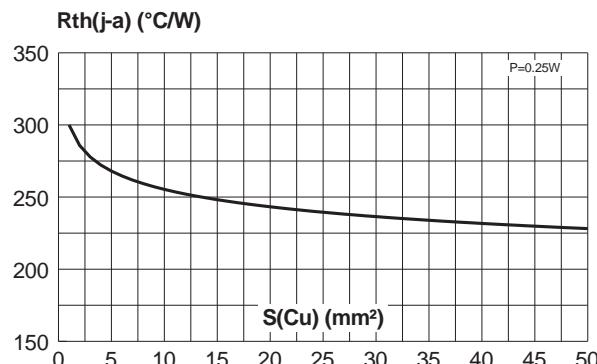
**Fig. 4:** Junction capacitance versus reverse voltage applied (typical values).



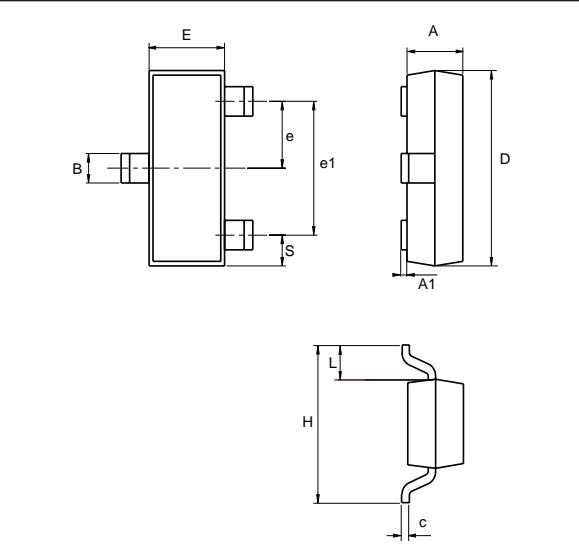
**Fig. 5:** Relative variation of thermal impedance junction to ambient versus pulse duration (alumine substrate 10mm\*8mm\*0.5mm).



**Fig. 6:** Thermal resistance junction to ambient versus copper surface under each lead (Epoxy printed circuit board FR4, copper thickness: 35 $\mu m$ ).

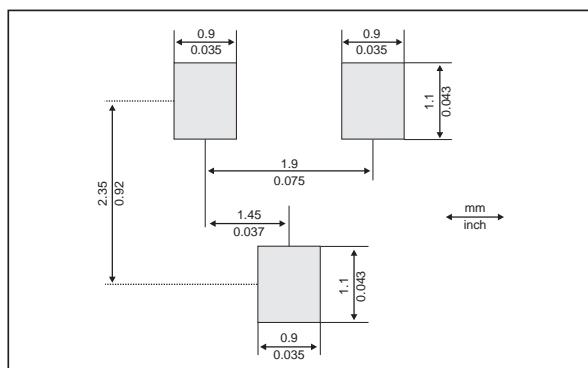


**PACKAGE MECHANICAL DATA**  
SOT23 (Plastic)



REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	0.89	1.4	0.035	0.055
A1	0	0.1	0	0.004
B	0.3	0.51	0.012	0.02
c	0.085	0.18	0.003	0.007
D	2.75	3.04	0.108	0.12
e	0.85	1.05	0.033	0.041
e1	1.7	2.1	0.067	0.083
E	1.2	1.6	0.047	0.063
H	2.1	2.75	0.083	0.108
L	0.6 typ.		0.024 typ.	
S	0.35	0.65	0.014	0.026

**FOOTPRINT DIMENSIONS**



Ordering type	Marking	Package	Weight	Base qty	Delivery mode
BAR18	D76	SOT-23	0.01g	3000	Tape & reel
BAS70-04	D96	SOT-23	0.01g	3000	Tape & reel
BAS70-05	D97	SOT-23	0.01g	3000	Tape & reel
BAS70-06	D98	SOT-23	0.01g	3000	Tape & reel

- Epoxy meets UL94,V0

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